



SPECIFICATION

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL21B183KBANFNC

Product : Multi-layer Ceramic Capacitor Description : CAP, 18nF, 50V, ±10%, X7R, 0805

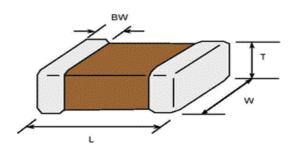
A. Samsung Part Number

 CL
 21
 B
 183
 K
 B
 A
 N
 F
 N
 C

 ①
 ②
 ③
 ④
 ⑤
 ⑥
 ⑦
 ⑧
 ⑨
 ⑩
 ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor				
2	Size	0805 (inch code)	L: 2.00 ±	± 0.10 mm	W : $1.25 \pm 0.10 \text{ mm}$	n
3	Dielectric	X7R	8	Inner electrode	Ni	
4	Capacitance	18 nF		Termination	Cu	
(5)	Capacitance	±10 %		Plating	Sn 100%	(Pb Free)
	tolerance		9	Product	Product for P	OWER application
6	Rated Voltage	50 V	10	Special	Reserved for	future use
7	Thickness	$0.65 \pm 0.10 \text{ mm}$	11)	Packaging	Cardboard Ty	pe, 7" reel

B. Structure & Dimension



Samsung P/N	Dimension(mm)				
Samsung F/N	L	W	Т	BW	
CL21B183KBANFNC	2.00 ± 0.10	1.25 ± 0.10	0.65 ± 0.10	0.50 + 0.2/-0.3	

C. Samsung Reliablility Test and Judgement Condition

CapacitanceWithin specified tolerance1 kHz ±10% / 1.0±0.2VrmsTan δ (DF)0.025 max.*A capacitor prior to measuring the capacitance is heat treated at 150 °C +0/-10 °C for 1hour and maintained in ambient air for 24±2 hours.Insulation10,000Mohm or 500Mohm×μFRated Voltage 60~120 sec.ResistanceWhichever is smallerAppearanceNo abnormal exterior appearanceMicroscope (×10)WithstandingNo dielectric breakdown or wechanical breakdown250% of the rated voltageVoltagemechanical breakdownTemperatureX7RCharacteristics(From-55 °C to 125 °C, Capacitance change should be within ±15%)Adhesive Strength of TerminationNo peeling shall be occur on the formination500g·f, for 10±1 sec.Bending StrengthCapacitance change: within ±12.5%Bending to the limit (1mm) with 1.0mm/sec.SolderabilityMore than 75% of terminal surfaceSnAg3.0Cu0.5 solder		Judgement	Test condition		
Tan δ (DF)0.025 max.treated at 150 °C +0/-10 °C for 1hour and maintained in ambient air for 24±2 hours.Insulation10,000Mohm or 500Mohm×μFRated Voltage60~120 sec.ResistanceWhichever is smallerMicroscope (×10)AppearanceNo abnormal exterior appearanceMicroscope (×10)WithstandingNo dielectric breakdown or mechanical breakdown250% of the rated voltageVoltageX7RX7RCharacteristics(From-55 °C to 125 °C, Capacitance change should be within ±15%)Adhesive Strength of TerminationNo peeling shall be occur on the terminal electrode500g·f, for 10±1 sec.Bending StrengthCapacitance change : within ±12.5%Bending to the limit (1mm) with 1.0mm/sec.	Capacitance	Within specified tolerance	1kHz ±10% / 1.0±0.2Vrms		
Resistance Appearance No abnormal exterior appearance Microscope (×10) Withstanding No dielectric breakdown or Voltage Temperature Characteristics (From-55°C to 125°C, Capacitance change should be within ±15%) Adhesive Strength of Termination Bending Strength Capacitance change: within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.		0.025 max.			
Appearance No abnormal exterior appearance Microscope (×10) Withstanding No dielectric breakdown or wechanical breakdown Temperature Characteristics (From-55°C to 125°C, Capacitance change should be within ±15%) Adhesive Strength of Termination Bending Strength Capacitance change: within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	Insulation 10,000Mohm or 500Mohm× <i>µ</i> F		Rated Voltage 60~120 sec.		
Withstanding No dielectric breakdown or wechanical breakdown 250% of the rated voltage Temperature X7R Characteristics (From-55℃ to 125℃, Capacitance change should be within ±15%) Adhesive Strength of Termination No peeling shall be occur on the terminal electrode 500g·f, for 10±1 sec. Bending Strength Capacitance change : within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	Resistance Whichever is smaller				
Voltage mechanical breakdown Temperature X7R Characteristics (From-55 ℃ to 125 ℃, Capacitance change should be within ±15%) Adhesive Strength of Termination No peeling shall be occur on the terminal electrode 500g·f, for 10±1 sec. Bending Strength Capacitance change : within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	Appearance No abnormal exterior appearance		Microscope (×10)		
Temperature X7R Characteristics (From-55℃ to 125℃, Capacitance change should be within ±15%) Adhesive Strength of Termination No peeling shall be occur on the terminal electrode 500g·f, for 10±1 sec. Bending Strength Capacitance change : within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.			250% of the rated voltage		
Characteristics (From-55℃ to 125℃, Capacitance change should be within ±15%) Adhesive Strength of Termination No peeling shall be occur on the terminal electrode 500g·f, for 10±1 sec. Bending Strength Capacitance change : within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	√oltage	mechanical breakdown			
Adhesive Strength of Termination Bending Strength Capacitance change: within ±12.5% Who peeling shall be occur on the terminal electrode Strength Capacitance change: within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	Геmperature	X7R			
of Termination terminal electrode Bending Strength Capacitance change : within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	Characteristics	(From-55℃ to 125℃, Capacitance change s	should be within ±15%)		
Bending Strength Capacitance change: within ±12.5% Bending to the limit (1mm) with 1.0mm/sec.	Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.		
with 1.0mm/sec.	of Termination	terminal electrode			
	Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)		
Solderability More than 75% of terminal surface SnAg3.0Cu0.5 solder			with 1.0mm/sec.		
	Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder		
is to be soldered newly 245±5°C, 3±0.3sec.		is to be soldered newly	245±5°C, 3±0.3sec.		
(preheating : 80~120°C for 10~30sec.)			(preheating : 80~120°C for 10~30sec.)		
Resistance to Capacitance change: within ±7.5% Solder pot: 270±5℃, 10±1sec.	Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.		
Soldering Heat Tan δ, IR : initial spec.	Soldering Heat	Tan δ, IR : initial spec.			
Vibration TestCapacitance change : within ± 5%Amplitude : 1.5mmTan δ, IR : initial spec.From 10Hz to 55Hz (return : 1min.)2hours × 3 direction (x, y, z)	/ibration Test	, · · · · · · · · · · · · · · · · · · ·	From 10Hz to 55Hz (return : 1min.)		
Moisture Capacitance change: within ±12.5% With rated voltage	Moisture	Capacitance change: within ±12.5%	With rated voltage		
Resistance Tan δ : 0.05 max 40±2℃, 90~95%RH, 500+12/-0hrs	Resistance	Tan δ : 0.05 max	40±2°C, 90~95%RH, 500+12/-0hrs		
IR : 500Mohm or 25Mohm × <i>μ</i> F					
Whichever is smaller		Whichever is smaller			
High Temperature Capacitance change: within ±12.5% With 200% of the rated voltage	High Temperature	Capacitance change : within ±12.5%	With 200% of the rated voltage		
Resistance Tan δ : 0.05 max Max. operating temperature	Resistance		1		
IR : 1,000Mohm or 50Mohm × <i>μ</i> F 1,000+48/-0hrs Whichever is smaller			1,000+48/-0hrs		
Temperature Capacitance change: within ±7.5% 1 cycle condition			1 cycle condition		
Cycling Tan δ , IR: initial spec. Min. operating temperature \rightarrow 25°C	-		The state of the s		
→ Max. operating temperature → 25°C					
		i e			
5 cycle test					

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260±5°C, 30sec.)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

Disclaimer & Limitation of Use and Application

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- 4 Military equipment
- ⑤ Disaster prevention/crime prevention equipment
- 6 Power plant control equipment
- Atomic energy-related equipment
- Undersea equipment
- Traffic signal equipment
- Data-processing equipment
- ## Electric heating apparatus, burning equipment
- Safety equipment
- ® Any other applications with the same as or similar complexity or reliability to the applications